

NC7SZ66

Low Voltage Single SPST Normally Open Bus Switch

General Description

The NC7SZ66 is a ultra high-speed (UHS) CMOS compatible single-pole/single-throw (SPST) bus switch. The LOW On Resistance of the switch allows inputs to be connected to outputs with minimal propagation delay and without generating additional ground bounce noise. The device is organized as a 1-bit switch with a switch enable (OE) signal. When OE is HIGH, the switch is on and Port A is connected to Port B. When OE is LOW, the switch is open and a high-impedance state exists between the two ports.

Features

- Space saving SOT23 or SC70 5-lead package
- Ultra small MicroPak™ Pb-Free leadless package
- Broad V_{CC} Operating Range 1.65V–5.5V
- Rail-to-rail signal handling
- \blacksquare 5 Ω switch connection between two ports
- Minimal propagation delay through the switch
- Low I_{CC}
- Zero bounce in flow-through mode
- Control input compatible with CMOS input levels

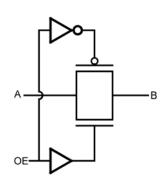
Ordering Code:

Order	Package	Product Code	Package Description	Supplied As	
Number	Number	Top Mark	Fackage Description	Supplied As	
NC7SZ66M5X	MA05B	7Z66	5-Lead SOT23, JEDEC MO-178, 1.6mm	3k Units on Tape and Reel	
NC7SZ66P5X	MAA05A	Z66	5-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3k Units on Tape and Reel	
NC7SZ66L6X	MAC06	EE	Pb-Free 6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel	

Pb-Free package per JEDEC J-STD-020B.

 $\label{eq:microPak} \mbox{MicroPak}^{\tiny{\text{TM}}} \mbox{ is a trademark of Fairchild Semiconductor Corporation.}$

Logic Symbol



Pin Descriptions

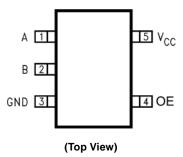
Pin Names	Description
OE	Switch Enable Input
A	Bus A I/O
В	Bus B I/O
NC	No Connect

Function Table

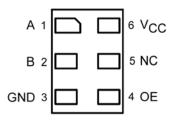
OE	B ₀	Function		
L	HIGH-Z State	Disconnect		
Н	A_0	Connect		

Connection Diagrams

Pin Assignments for SC70



Pad Assignment for MicroPak



(Top Through View)

Absolute Maximum Ratings(Note 1)

Supply Voltage (V _{CC})	-0.5V to $+7.0V$
DC Switch Voltage (V _S)	$-0.5V$ to V_{CC} $+0.5V$
DC Input Voltage (V _{IN}) (Note 2)	-0.5V to $+7.0V$
DC Input Diode Current	
$(I_{IK}) V_{IN} < 0V$	−50 mA
DC Output (I _{OUT}) Sink Current	128 mA
DC V _{CC} /GND Current (I _{CC} /I _{GND})	±100 mA
Storage Temperature Range	
(T _{STG})	-65°C to +150°C
	-65°C to +150°C
(T _{STG})	-65°C to +150°C +150°C
(T _{STG}) Junction Lead Temperature	
(T _{STG}) Junction Lead Temperature under Bias (T _J)	
(T _{STG}) Junction Lead Temperature under Bias (T _J) Junction Lead Temperature (T _L)	+150°C
(T _{STG}) Junction Lead Temperature under Bias (T _J) Junction Lead Temperature (T _L) (Soldering, 10 Seconds)	+150°C

Recommended Operating Conditions (Note 3)

Power Supply Operating (V _{CC})	1.65V to 5.5V
Control Input Voltage (VIN)	0V to 5.5V
Switch Input Voltage (V _{IN})	0V to V_{CC}
Switch Output Voltage (V _{OUT})	0V to V_{CC}
Input Rise and Fall Time (t_r, t_f)	
Control Input; V _{CC} = 2.3V-3.6V	0 ns/V to 10 ns
Control Input; V _{CC} = 4.5–5.5V	0 ns/V to 5 ns
Switch I/O	0 ns/V to DC
Operating Temperature (T _A)	-40°C to $+85$ °C
Thermal Resistance (θ_{JA})	
SOT23-5	300°C/Watt
CC70 F	42E°C AMott

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

Note 3: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

		V _{CC}	T _A = -40°C to +85°C			$T_A = +25^{\circ}C$				
Symbol	Parameter	(V)	Min	Typ (Note 5)	Max	Min	Тур	Max	Units	Conditions
V _{IH}	HIGH Level	1.65 to 1.95	0.75 V _{CC}						V	
	Input Voltage	2.3 to 5.5	0.7 V _{CC}						v	
V _{IL}	LOW Level	1.65 to 1.95			0.25 V _{CC}				V	
	Input Voltage	2.3 to 5.5			0.3 V _{CC}]	
I _{IN}	Control Input Leakage Current	0 to 5.5		±0.05	±1.0				μА	$0 \le V_{IN} \le 5.5V$
I _{OFF}	OFF Leakage Current	1.65 to 5.5		±0.05	±10.0				μА	$0 \le A, B \le V_{CC}$
R _{ON}	Switch On Resistance			3.0	7.0					$V_{IN} = 0V$, $I_{IN} = 30 \text{ mA}$
	(Note 4)	4.5		5.0	12.0					$V_{IN} = 2.4V, I_{IN} = 15 \text{ mA}$
				7.0	15.0					$V_{IN} = 4.5V$, $I_{IN} = 30 \text{ mA}$
		3.0		4.0	9.0					$V_{IN} = 0V$, $I_{IN} = 24$ mA
				10.0	20.0				Ω	$V_{IN} = 3V$, $I_{IN} = 24$ mA
		2.3		5.0	12.0					$V_{IN} = 0V$, $I_{IN} = 8$ mA
		2.0		13.0	30.0					$V_{IN} = 2.3V$, $I_{IN} = 8 \text{ mA}$
		1.8		7.0	28.0					$V_{IN} = 0V$, $I_{IN} = 4$ mA
		1.0		25.0	60.0					$V_{IN} = 1.8V$, $I_{IN} = 4 \text{ mA}$
R _{flat}	On Resistance Flatness	5.0					6.0			$I_A = -30~mA, 0 \leq V_{Bn} \leq V_{CC}$
	(Note 4)(Note 6)(Note 7)	3.3					12.0		Ω	$I_A = -24 \text{ mA}, 0 \leq V_{Bn} \leq V_{CC}$
		2.5					28.0		32	$I_A = -8~mA,~0 \leq V_{Bn} \leq V_{CC}$
		1.8					125			$I_A = -4 \ mA, \ 0 \le V_{Bn} \le V_{CC}$
I _{cc}	Quiescent Supply Current	1.65 to 5.5		0.05	10.0				μА	$V_{IN} = V_{CC}$ or GND $I_{OUT} = 0$

Note 4: Measured by the voltage drop between A and B pins at the indicated current through the switch. On Resistance is determined by the lower of the voltages on the two (A or B) pins.

Note 5: All typical values are at the specified $V_{CC},$ and $T_A=25^{\circ}C.$

Note 6: Parameter is characterized but not tested in production.

Note 7: Flatness is defined as the difference between the maximum and minimum value of On Resistance over the specified range of conditions.

AC Electrical Characteristics

			T _A = -40°C to +85°C,					
Symbol	Parameter	V _{CC}	C _L = 5	0 pF, RU = RD	= 500 Ω	Units	Conditions	Figure
		(V)	Min	Typ (Note 8)	Max			Number
t _{PHL} , t _{PLH}	Propagation Delay Bus to Bus	1.65 to 1.95			4.3			
	(Note 9)	2.3-2.7			1.2	ns	V _{IN} = OPEN	Figures
		3.0-3.6			0.8	ns	1	1, 2
		4.5-5.5			0.3	ns	7	
t_{PZL}, t_{PZH}	Output Enable Time	1.65 to 1.95	1.5	7.0	14.2		V _{IN} = 2 x V _{CC} for t _{PZL}	
		2.3-2.7	1.5	3.3	7.0	ns		Figures
		3.0-3.6	1.5	2.4	5.5	ns	V _{IN} = 0V for t _{PZH}	1, 2
		4.5-5.5	1.5	2.0	4.5	ns	1	
t_{PLZ} , t_{PHZ}	Output Disable Time	1.65 to 1.95	1.5	9.2	18.2			
		2.3-2.7	1.5	5.3	9.0	ns	V _{IN} = 2 x V _{CC} for t _{PLZ}	Figures
		3.0-3.6	1.5	4.0	7.0	ns	V _{IN} = 0V for t _{PHZ}	1Figure 2
		4.5-5.5	1.5	2.7	5.0	ns	1	

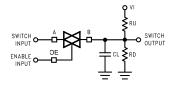
Note 8: All typical values are at the specified $V_{CC},$ and $T_A=25\,^{\circ}C.$

Note 9: This parameter is guaranteed by design but is not tested. The switch contributes no propagation delay other than the RC delay of the typical On Resistance of the switch and the 50 pF load capacitance, when driven by an ideal voltage source (zero output impedance).

Capacitance

Symbol	Parameter	Тур	Max	Units	Conditions
C _{IN}	Control Pin Input Capacitance			pF	V _{CC} = 0V
C _{I/O}	Input/Output Capacitance	6		pF	V _{CC} = 5.0V

AC Loading and Waveforms

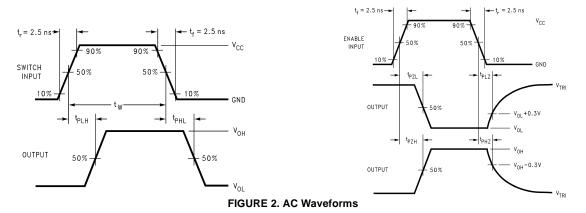


Input driven by 50Ω source terminated in 50Ω

 $\mathbf{C}_{\mathbf{L}}$ includes load and stray capacitance.

Input PRR = 1.0 MHz; $t_{\text{w}} = 500 \text{ ns}$

FIGURE 1. AC Test Circuit

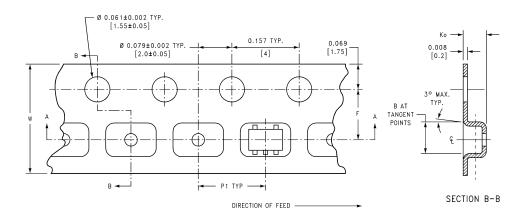


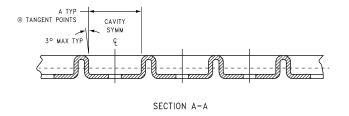
Tape and Reel Specification

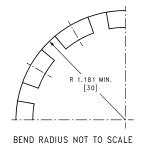
TAPE FORMAT for SOT23 and SC70

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status	
	Leader (Start End)	125 (typ)	Empty	Sealed	
M5X, P5X	Carrier	3000	Filled	Sealed	
	Trailer (Hub End)	75 (typ)	Empty	Sealed	

TAPE DIMENSIONS inches (millimeters)





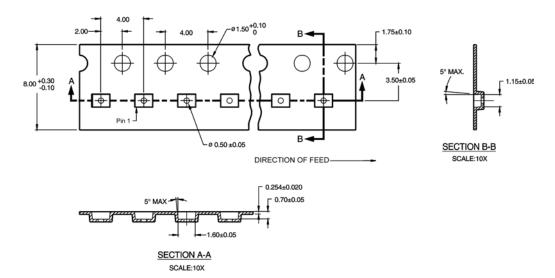


Package	Tape Size	DIM A	DIM B	DIM F	DIM K _o	DIM P1	DIM W
SC70-5	0 mm	0.093	0.096	0.138 ± 0.004	0.053 ± 0.004	0.157	0.315 ± 0.004
SC70-5	8 mm	(2.35)	(2.45)	(3.5 ± 0.10)	(1.35 ± 0.10)	(4)	(8 ± 0.1)
SOT23-5	8 mm	0.130	0.130	0.138 ± 0.002	0.055 ± 0.004	0.157	0.315 ± 0.012
30123-5		(3.3)	(3.3)	(3.5 ± 0.05)	(1.4 ± 0.11)	(4)	(8 ± 0.3)

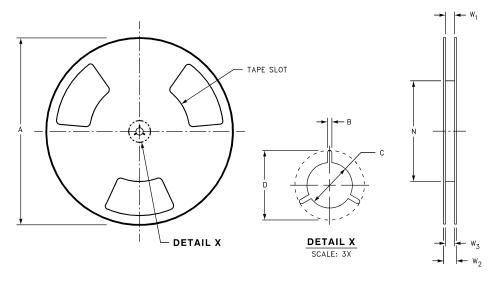
TAPE FORMAT for MicroPak

Package	Tape	Number	Cavity	Cover Tape	
Designator	Section	Cavities	Status	Status	
	Leader (Start End)	125 (typ)	Empty	Sealed	
L6X	Carrier	5000	Filled	Sealed	
	Trailer (Hub End)	75 (typ)	Empty	Sealed	

TAPE DIMENSIONS inches (millimeters)

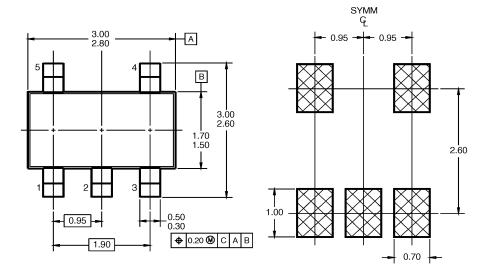


REEL DIMENSIONS inches (millimeters)

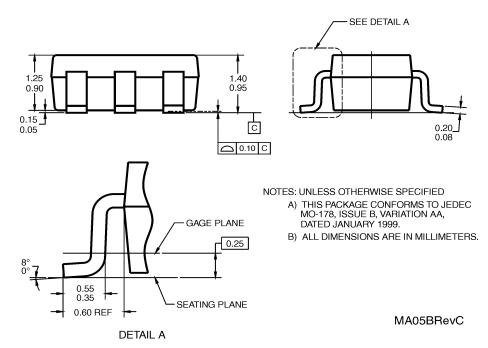


Tape Size	Α	В	С	D	N	W1	W2	W3
8 mm	7.0	0.059	0.512	0.795	2.165	0.331 + 0.059/-0.000	0.567	W1 + 0.078/-0.039
O IIIIII	(177.8)	(1.50)	(13.00)	(20.20)	(55.00)	(8.40 + 1.50/-0.00)	(14.40)	(W1 + 2.00/-1.00)

Physical Dimensions inches (millimeters) unless otherwise noted

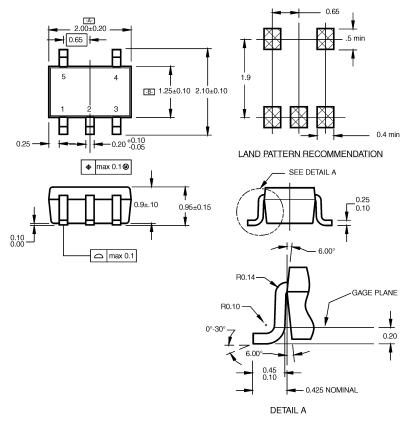


LAND PATTERN RECOMMENDATION



5-Lead SOT23, JEDEC MO-178, 1.6mm Package Number MA05B

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



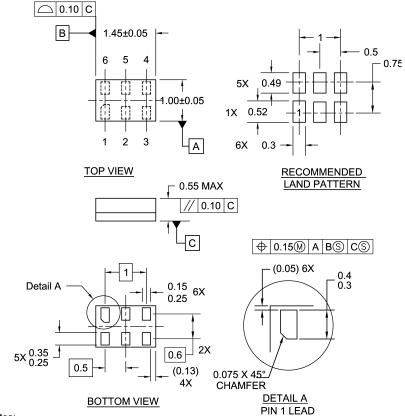
NOTES:

- A. CONFORMS TO EIAJ REGISTERED OUTLINE DRAWING SC88A.
- $\ensuremath{\mathsf{B}}.$ DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH.
- C. DIMENSIONS ARE IN MILLIMETERS.

MAA05ARevC

5-Lead SC70, EIAJ SC-88a, 1.25mm Wide Package Number MAA05A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Notes:

- 1. JEDEC PACKAGE REGISTRATION IS ANTICIPATED 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06ARevB

Pb-Free 6-Lead MicroPak, 1.0mm Wide Package Number MAC06A

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